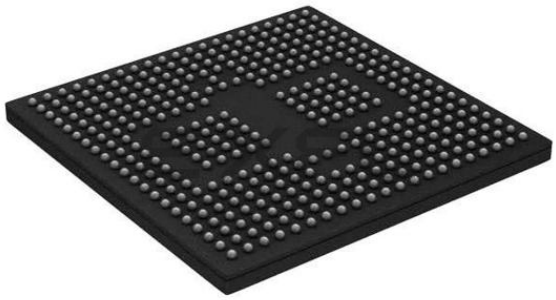


Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	XCore
Core Size	32-Bit 24-Core
Speed	4000MIPS
Connectivity	-
Peripherals	-
Number of I/O	176
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512K x 8
Voltage - Supply (Vcc/Vdd)	0.95V ~ 3.6V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	374-LFBGA
Supplier Device Package	374-FBGA (18x18)
Purchase URL	https://www.e-xfl.com/product-detail/xmos/xlf224-512-fb374-c40

on events generated by hardware resources such as the I/O pins, communication channels and timers. Once triggered, a core runs independently and concurrently to other cores, until it pauses to wait for more events. Section 6.2

- **Channels and channel ends** Tasks running on logical cores communicate using channels formed between two channel ends. Data can be passed synchronously or asynchronously between the channel ends assigned to the communicating tasks. Section 6.5
- **xCONNECT Switch and Links** Between tiles, channel communications are implemented over a high performance network of xCONNECT Links and routed through a hardware xCONNECT Switch. Section 6.6
- **Ports** The I/O pins are connected to the processing cores by Hardware Response ports. The port logic can drive its pins high and low, or it can sample the value on its pins optionally waiting for a particular condition. Section 6.3
- **Clock blocks** xCORE devices include a set of programmable clock blocks that can be used to govern the rate at which ports execute. Section 6.4
- **Memory** Each xCORE Tile integrates a bank of SRAM for instructions and data, and a block of one-time programmable (OTP) memory that can be configured for system wide security features. Section 9
- **PLL** The PLL is used to create a high-speed processor clock given a low speed external oscillator. Section 7
- **Flash** The device has a built-in 2MBflash. Section 8
- **JTAG** The JTAG module can be used for loading programs, boundary scan testing, in-circuit source-level debugging and programming the OTP memory. Section 10

1.1 Software

Devices are programmed using C, C++ or xC (C with multicore extensions). XMOS provides tested and proven software libraries, which allow you to quickly add interface and processor functionality such as USB, Ethernet, PWM, graphics driver, and audio EQ to your applications.

1.2 xTIMEcomposer Studio

The xTIMEcomposer Studio development environment provides all the tools you need to write and debug your programs, profile your application, and write images into flash memory or OTP memory on the device. Because xCORE devices operate deterministically, they can be simulated like hardware within xTIMEcomposer: uniquely in the embedded world, xTIMEcomposer Studio therefore includes a static timing analyzer, cycle-accurate simulator, and high-speed in-circuit instrumentation.

xTIMEcomposer can be driven from either a graphical development environment, or the command line. The tools are supported on Windows, Linux and MacOS X

2 XLF224-512-FB374 Features

- **Multicore Microcontroller with Advanced Multi-Core RISC Architecture**
  - 24 real-time logical cores on 4 xCORE tiles
  - Cores share up to 2000 MIPS
    - Up to 4000 MIPS in dual issue mode
  - Each logical core has:
    - Guaranteed throughput of between 1/5 and 1/6 of tile MIPS
    - 16x32bit dedicated registers
  - 167 high-density 16/32-bit instructions
    - All have single clock-cycle execution (except for divide)
    - 32x32→64-bit MAC instructions for DSP, arithmetic and user-definable cryptographic functions
- **Programmable I/O**
  - 256 general-purpose I/O pins, configurable as input or output
    - Up to 56 x 1bit port, 22 x 4bit port, 13 x 8bit port, 6 x 16bit port, 4 x 32bit port
    - 8 xCONNECT links
  - Port sampling rates of up to 60 MHz with respect to an external clock
  - 128 channel ends (32 per tile) for communication with other cores, on or off-chip
- **Memory**
  - 512KB internal single-cycle SRAM (max 128KB per tile) for code and data storage
  - 32KB internal OTP (max 8KB per tile) for application boot code
  - 2MB internal flash for application code and overlays
- **Hardware resources**
  - 24 clock blocks (6 per tile)
  - 40 timers (10 per tile)
  - 16 locks (4 per tile)
- **JTAG Module for On-Chip Debug**
- **Security Features**
  - Programming lock disables debug and prevents read-back of memory contents
  - AES bootloader ensures secrecy of IP held on external flash memory
- **Ambient Temperature Range**
  - Commercial qualification: 0°C to 70°C
  - Industrial qualification: -40°C to 85°C
- **Speed Grade**
  - 40: 2000 MIPS
- **Power Consumption**
  - 1140 mA (typical)
- **374-pin FBGA package 0.8 mm pitch**

Signal	Function					Type	Properties
X1D17	$X_0L3^0_{in}$		4D[1]	8B[3]	16A[11]	I/O	IO, PD
X1D18	$X_0L3^0_{out}$		4D[2]	8B[4]	16A[12]	I/O	IO, PD
X1D19	$X_0L3^1_{out}$		4D[3]	8B[5]	16A[13]	I/O	IO, PD
X1D20			4C[2]	8B[6]	16A[14] 32A[30]	I/O	IO, PD
X1D21			4C[3]	8B[7]	16A[15] 32A[31]	I/O	IO, PD
X1D22	$X_0L3^4_{out}$	1G[0]				I/O	IO, PD
X1D23		1H[0]				I/O	IO, PD
X1D24		1I[0]				I/O	IO, PD
X1D25		1J[0]				I/O	IO, PD
X1D26			4E[0]	8C[0]	16B[0]	I/O	IOT, PD
X1D27			4E[1]	8C[1]	16B[1]	I/O	IOT, PD
X1D28			4F[0]	8C[2]	16B[2]	I/O	IOT, PD
X1D29			4F[1]	8C[3]	16B[3]	I/O	IOT, PD
X1D30			4F[2]	8C[4]	16B[4]	I/O	IOT, PD
X1D31			4F[3]	8C[5]	16B[5]	I/O	IOT, PD
X1D32			4E[2]	8C[6]	16B[6]	I/O	IOT, PD
X1D33			4E[3]	8C[7]	16B[7]	I/O	IOT, PD
X1D34	$X_0L0^2_{out}$	1K[0]				I/O	IO, PD
X1D35	$X_0L0^3_{out}$	1L[0]				I/O	IO, PD
X1D36	$X_0L0^4_{out}$	1M[0]		8D[0]	16B[8]	I/O	IO, PD
X1D37	$X_0L3^4_{in}$	1N[0]		8D[1]	16B[9]	I/O	IO, PD
X1D38	$X_0L3^3_{in}$	1O[0]		8D[2]	16B[10]	I/O	IO, PD
X1D39	$X_0L3^2_{in}$	1P[0]		8D[3]	16B[11]	I/O	IO, PD
X1D40				8D[4]	16B[12]	I/O	IOT, PD
X1D41				8D[5]	16B[13]	I/O	IOT, PD
X1D42				8D[6]	16B[14]	I/O	IOT, PD
X1D43				8D[7]	16B[15]	I/O	IOT, PD
X1D49	$X_0L1^4_{in}$				32A[0]	I/O	IO, PD
X1D50	$X_0L1^3_{in}$				32A[1]	I/O	IO, PD
X1D51	$X_0L1^2_{in}$				32A[2]	I/O	IO, PD
X1D52	$X_0L1^1_{in}$				32A[3]	I/O	IO, PD
X1D53	$X_0L1^0_{in}$				32A[4]	I/O	IO, PD
X1D54	$X_0L1^0_{out}$				32A[5]	I/O	IO, PD
X1D55	$X_0L1^1_{out}$				32A[6]	I/O	IO, PD
X1D56	$X_0L1^2_{out}$				32A[7]	I/O	IO, PD
X1D57	$X_0L1^3_{out}$				32A[8]	I/O	IO, PD
X1D58	$X_0L1^4_{out}$				32A[9]	I/O	IO, PD
X1D61	$X_0L2^4_{in}$				32A[10]	I/O	IO, PD
X1D62	$X_0L2^3_{in}$				32A[11]	I/O	IO, PD
X1D63	$X_0L2^2_{in}$				32A[12]	I/O	IO, PD
X1D64	$X_0L2^1_{in}$				32A[13]	I/O	IO, PD
X1D65	$X_0L2^0_{in}$				32A[14]	I/O	IO, PD
X1D66	$X_0L2^0_{out}$				32A[15]	I/O	IO, PD

(continued)

Signal	Function	Type	Properties
X3D32	4E[2] 8C[6] 16B[6]	I/O	IOT, PD
X3D33	4E[3] 8C[7] 16B[7]	I/O	IOT, PD
X3D40	8D[4] 16B[12]	I/O	IOT, PD
X3D41	8D[5] 16B[13]	I/O	IOT, PD
X3D42	8D[6] 16B[14]	I/O	IOT, PD
X3D43	8D[7] 16B[15]	I/O	IOT, PD

System pins (4)			
Signal	**Function**	**Type**	**Properties**
CLK	PLL reference clock	Input	IO, PD, ST
DEBUG_N	Multi-chip debug	I/O	IO, PU
MODE0	Boot mode select	Input	PU
MODE1	Boot mode select	Input	PU

ports are available. All pins of a port provide either output or input. Signals in different directions cannot be mapped onto the same port.

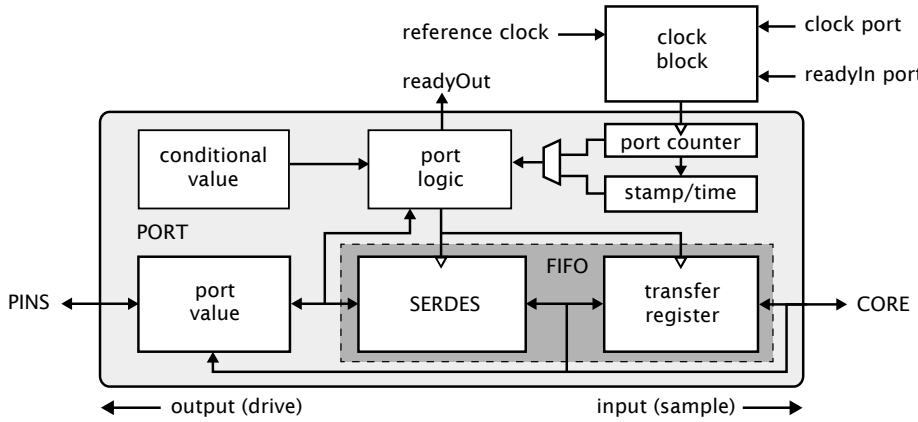


Figure 4: Port block diagram

The port logic can drive its pins high or low, or it can sample the value on its pins, optionally waiting for a particular condition. Ports are accessed using dedicated instructions that are executed in a single processor cycle. xCORE-200 IO pins can be used as *open collector* outputs, where signals are driven low if a zero is output, but left high impedance if a one is output. This option is set on a per-port basis.

Data is transferred between the pins and core using a FIFO that comprises a SERDES and transfer register, providing options for serialization and buffered data.

Each port has a 16-bit counter that can be used to control the time at which data is transferred between the port value and transfer register. The counter values can be obtained at any time to find out when data was obtained, or used to delay I/O until some time in the future. The port counter value is automatically saved as a timestamp, that can be used to provide precise control of response times.

The ports and xCONNECT links are multiplexed onto the physical pins. If an xConnect Link is enabled, the pins of the underlying ports are disabled. If a port is enabled, it overrules ports with higher widths that share the same pins. The pins on the wider port that are not shared remain available for use when the narrower port is enabled. Ports always operate at their specified width, even if they share pins with another port.

6.4 Clock blocks

xCORE devices include a set of programmable clocks called clock blocks that can be used to govern the rate at which ports execute. Each xCORE tile has six clock blocks: the first clock block provides the tile reference clock and runs at a default frequency of 100MHz; the remaining clock blocks can be set to run at different frequencies.

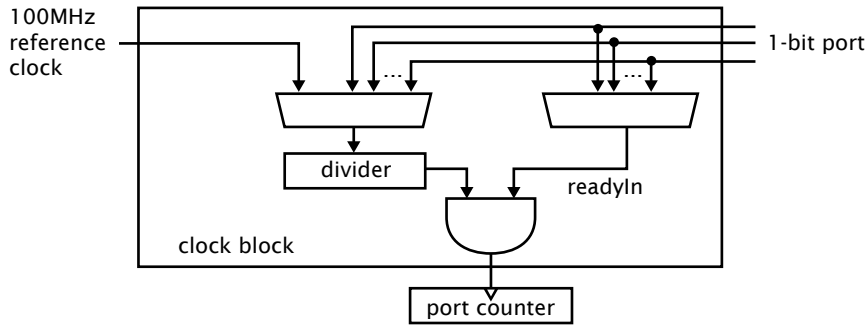


Figure 5: Clock block diagram

A clock block can use a 1-bit port as its clock source allowing external application clocks to be used to drive the input and output interfaces. xCORE-200 clock blocks optionally divide the clock input from a 1-bit port.

In many cases I/O signals are accompanied by strobing signals. The xCORE ports can input and interpret strobe (known as readyIn and readyOut) signals generated by external sources, and ports can generate strobe signals to accompany output data.

On reset, each port is connected to clock block 0, which runs from the xCORE Tile reference clock.

6.5 Channels and Channel Ends

Logical cores communicate using point-to-point connections, formed between two channel ends. A channel-end is a resource on an xCORE tile, that is allocated by the program. Each channel-end has a unique system-wide identifier that comprises a unique number and their tile identifier. Data is transmitted to a channel-end by an output-instruction; and the other side executes an input-instruction. Data can be passed synchronously or asynchronously between the channel ends.

6.6 xCONNECT Switch and Links

XMOS devices provide a scalable architecture, where multiple xCORE devices can be connected together to form one system. Each xCORE device has an xCONNECT interconnect that provides a communication infrastructure for all tasks that run on the various xCORE tiles on the system.

The interconnect relies on a collection of switches and XMOS links. Each xCORE device has an on-chip switch that can set up circuits or route data. The switches are connected by xConnect Links. An XMOS link provides a physical connection between two switches. The switch has a routing algorithm that supports many different topologies, including lines, meshes, trees, and hypercubes.

The links operate in either 2 wires per direction or 5 wires per direction mode, depending on the amount of bandwidth required. Circuit switched, streaming

Feature	Bit	Description
Disable JTAG	0	The JTAG interface is disabled, making it impossible for the tile state or memory content to be accessed via the JTAG interface.
Disable Link access	1	Other tiles are forbidden access to the processor state via the system switch. Disabling both JTAG and Link access transforms an xCORE Tile into a “secure island” with other tiles free for non-secure user application code.
Secure Boot	5	The xCORE Tile is forced to boot from address 0 of the OTP, allowing the xCORE Tile boot ROM to be bypassed (*see* §8).
Redundant rows	7	Enables redundant rows in OTP.
Sector Lock 0	8	Disable programming of OTP sector 0.
Sector Lock 1	9	Disable programming of OTP sector 1.
Sector Lock 2	10	Disable programming of OTP sector 2.
Sector Lock 3	11	Disable programming of OTP sector 3.
OTP Master Lock	12	Disable OTP programming completely: disables updates to all sectors and security register.
Disable JTAG-OTP	13	Disable all (read & write) access from the JTAG interface to this OTP.
Disable Global Debug	14	Disables access to the DEBUG_N pin.
	21..15	General purpose software accessable security register available to end-users.
	31..22	General purpose user programmable JTAG UserID code extension.

Figure 10: Security register features

register is loaded from the OTP on power up. All additional data in OTP is copied from the OTP to SRAM and executed first on the processor.

The OTP memory is programmed using three special I/O ports: the OTP address port is a 16-bit port with resource ID 0x100200, the OTP data is written via a 32-bit port with resource ID 0x200100, and the OTP control is on a 16-bit port with ID 0x100300. Programming is performed through `libotp` and `xburn`.

9.2 SRAM

Each xCORE Tile integrates a single 128KB SRAM bank for both instructions and data. All internal memory is 32 bits wide, and instructions are either 16-bit or 32-bit. Byte (8-bit), half-word (16-bit) or word (32-bit) accesses are supported and are executed within one tile clock cycle. There is no dedicated external memory interface, although data memory can be expanded through appropriate use of the ports.

The JTAG usercode register can be read by using the USERCODE instruction. Its contents are specified in Figure 13. The OTP User ID field is read from bits [22:31] of the security register on xCORE Tile 0, *see* §9.1 (all zero on unprogrammed devices).

Figure 13: USERCODE return value

Bit31										Usercode Register																				Bit0
OTP User ID										Unused				Silicon Revision																
0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0
0				0				0				2				8				0				0						

11 Board Integration

The device has the following power supply pins:

- VDD pins for the xCORE Tile
- VDDIO pins for the I/O lines
- PLL_AVDD pins for the PLL
- OTP_VCC pins for the OTP

Several pins of each type are provided to minimize the effect of inductance within the package, all of which must be connected. The power supplies must be brought up monotonically and input voltages must not exceed specification at any time.

The VDD supply must ramp from 0 V to its final value within 10 ms to ensure correct startup.

The VDDIO and OTP_VCC supply must ramp to its final value before VDD reaches 0.4 V.

The PLL_AVDD supply should be separated from the other noisier supplies on the board. The PLL requires a very clean power supply, and a low pass filter (for example, a 2.2 Ω resistor and 100 nF multi-layer ceramic capacitor) is recommended on this pin.

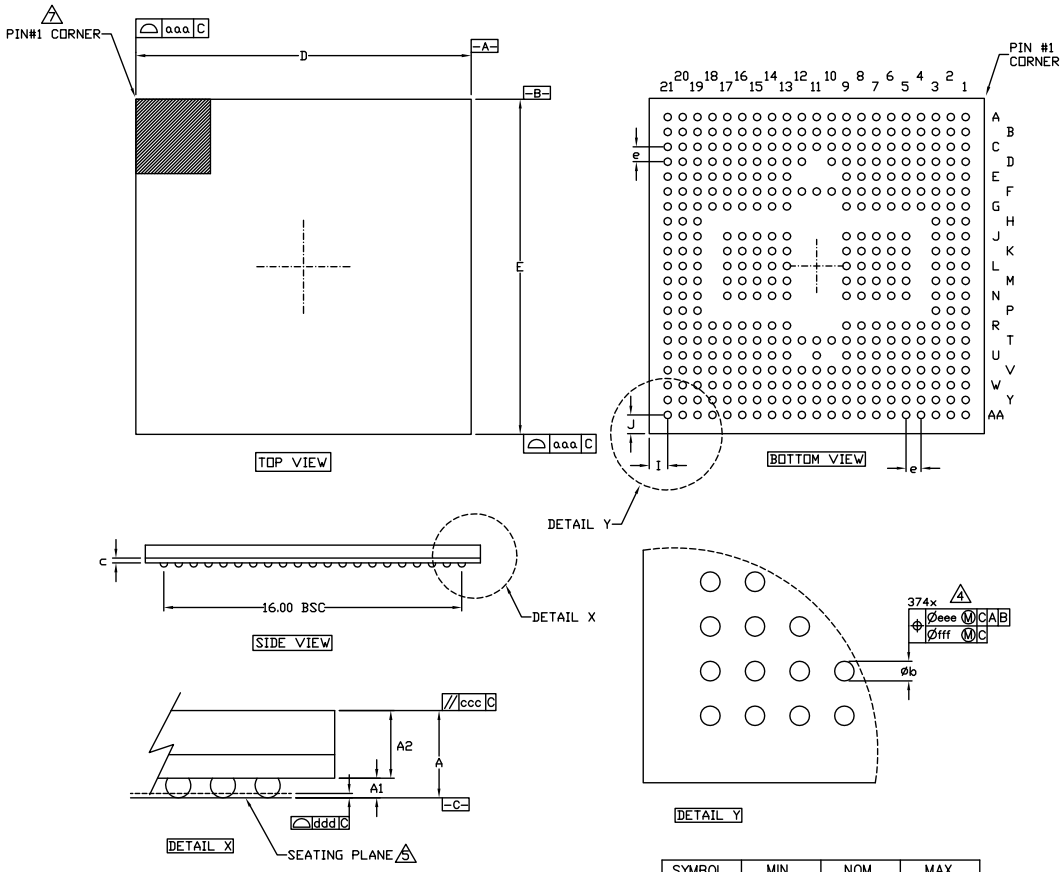
The following ground pins are provided:

- PLL_AGND for PLL_AVDD
- GND for all other supplies

All ground pins must be connected directly to the board ground.

The VDD and VDDIO supplies should be decoupled close to the chip by several 100 nF low inductance multi-layer ceramic capacitors between the supplies and GND (for example, 100nF 0402 for every other supply pin). The ground side of the decoupling capacitors should have as short a path back to the GND pins as possible. A bulk decoupling capacitor of at least 10 uF should be placed on each of these supplies.

13 Package Information



SYMBOL	MIN.	NOM.	MAX.
A	1.16	1.26	1.36
A1	0.25	0.30	0.35
A2	0.91	0.96	1.01
D	17.90	18.00	18.10
E	17.90	18.00	18.10
I	1.00 REF.		
J	1.00 REF.		
M	21x21<DEPOPULATED>		
aaa			0.15
ccc			0.20
ddd			0.10
eee			0.15
fff			0.08
b	0.35	0.40	0.45
e	0.80 BSC.		
c	0.26 REF.		

NOTE:

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. "e" REPRESENTS THE BASIC SOLDER BALL GRID PITCH.
3. "M" REPRESENTS THE MAXIMUM SOLDER BALL MATRIX SIZE.
4. DEMENSIONS "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER PARALLEL TO PRIMARY DATUM C .
5. PRIMARY DATUM C AND SEATING PLANE ARE DESIGNED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
6. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
7. A1 CORNER MUST BE IDENTIFIED BY LASER MARK.

B Processor Status Configuration

The processor status control registers can be accessed directly by the processor using processor status reads and writes (use `getps(reg)` and `setps(reg,value)` for reads and writes).

Number	Perm	Description
0x00	RW	RAM base address
0x01	RW	Vector base address
0x02	RW	xCORE Tile control
0x03	RO	xCORE Tile boot status
0x05	RW	Security configuration
0x06	RW	Ring Oscillator Control
0x07	RO	Ring Oscillator Value
0x08	RO	Ring Oscillator Value
0x09	RO	Ring Oscillator Value
0x0A	RO	Ring Oscillator Value
0x0C	RO	RAM size
0x10	DRW	Debug SSR
0x11	DRW	Debug SPC
0x12	DRW	Debug SSP
0x13	DRW	DGETREG operand 1
0x14	DRW	DGETREG operand 2
0x15	DRW	Debug interrupt type
0x16	DRW	Debug interrupt data
0x18	DRW	Debug core control
0x20 .. 0x27	DRW	Debug scratch
0x30 .. 0x33	DRW	Instruction breakpoint address
0x40 .. 0x43	DRW	Instruction breakpoint control
0x50 .. 0x53	DRW	Data watchpoint address 1
0x60 .. 0x63	DRW	Data watchpoint address 2
0x70 .. 0x73	DRW	Data breakpoint control register
0x80 .. 0x83	DRW	Resources breakpoint mask
0x90 .. 0x93	DRW	Resources breakpoint value
0x9C .. 0x9F	DRW	Resources breakpoint control register

Figure 27: Summary

Bits	Perm	Init	Description
31:11	RO	-	Reserved
10	DRW		Address space indentifier
9	DRW		Determines the issue mode (DI bit) upon Kernel Entry after Exception or Interrupt.
8	RO		Determines the issue mode (DI bit).
7	DRW		When 1 the thread is in fast mode and will continually issue.
6	DRW		When 1 the thread is paused waiting for events, a lock or another resource.
5	RO	-	Reserved
4	DRW		1 when in kernel mode.
3	DRW		1 when in an interrupt handler.
2	DRW		1 when in an event enabling sequence.
1	DRW		When 1 interrupts are enabled for the thread.
0	DRW		When 1 events are enabled for the thread.

0x10: Debug SSR

B.13 Debug SPC: 0x11

This register contains the value of the SPC register when the debugger was called.

0x11: Debug SPC

Bits	Perm	Init	Description
31:0	DRW		Value.

B.14 Debug SSP: 0x12

This register contains the value of the SSP register when the debugger was called.

0x12: Debug SSP

Bits	Perm	Init	Description
31:0	DRW		Value.

B.15 DGETREG operand 1: 0x13

The resource ID of the logical core whose state is to be read.

Bits	Perm	Init	Description
31:24	RO	-	Reserved
23:16	DRW	0	A bit for each thread in the machine allowing the breakpoint to be enabled individually for each thread.
15:3	RO	-	Reserved
2	DRW	0	When 1 the breakpoints will be be triggered on loads.
1	DRW	0	Determines the break condition: 0 = A AND B, 1 = A OR B.
0	DRW	0	When 1 the instruction breakpoint is enabled.

0x70 .. 0x73: Data breakpoint control register

B.26 Resources breakpoint mask: 0x80 .. 0x83

This set of registers contains the mask for the four resource watchpoints.

Bits	Perm	Init	Description
31:0	DRW		Value.

0x80 .. 0x83: Resources breakpoint mask

B.27 Resources breakpoint value: 0x90 .. 0x93

This set of registers contains the value for the four resource watchpoints.

Bits	Perm	Init	Description
31:0	DRW		Value.

0x90 .. 0x93: Resources breakpoint value

B.28 Resources breakpoint control register: 0x9C .. 0x9F

This set of registers controls each of the four resource watchpoints.

0x00: Device identification

Bits	Perm	Init	Description
31:24	CRO		Processor ID of this XCore.
23:16	CRO		Number of the node in which this XCore is located.
15:8	CRO		XCore revision.
7:0	CRO		XCore version.

C.2 xCORE Tile description 1: 0x01

This register describes the number of logical cores, synchronisers, locks and channel ends available on this xCORE tile.

0x01: xCORE Tile description 1

Bits	Perm	Init	Description
31:24	CRO		Number of channel ends.
23:16	CRO		Number of the locks.
15:8	CRO		Number of synchronisers.
7:0	RO	-	Reserved

C.3 xCORE Tile description 2: 0x02

This register describes the number of timers and clock blocks available on this xCORE tile.

0x02: xCORE Tile description 2

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:8	CRO		Number of clock blocks.
7:0	CRO		Number of timers.

C.4 Control PSwitch permissions to debug registers: 0x04

This register can be used to control whether the debug registers (marked with permission CRW) are accessible through the tile configuration registers. When this bit is set, write -access to those registers is disabled, preventing debugging of the xCORE tile over the interconnect.

0x07: Security configuration

Bits	Perm	Init	Description
31	CRO		Disables write permission on this register
30:15	RO	-	Reserved
14	CRO		Disable access to XCore's global debug
13	RO	-	Reserved
12	CRO		lock all OTP sectors
11:8	CRO		lock bit for each OTP sector
7	CRO		Enable OTP reduanacy
6	RO	-	Reserved
5	CRO		Override boot mode and read boot image from OTP
4	CRO		Disable JTAG access to the PLL/BOOT configuration registers
3:1	RO	-	Reserved
0	CRO		Disable access to XCore's JTAG debug TAP

C.8 Debug scratch: 0x20 .. 0x27

A set of registers used by the debug ROM to communicate with an external debugger, for example over the switch. This is the same set of registers as the Debug Scratch registers in the processor status.

0x20 .. 0x27: Debug scratch

Bits	Perm	Init	Description
31:0	CRW		Value.

C.9 PC of logical core 0: 0x40

Value of the PC of logical core 0.

0x40: PC of logical core 0

Bits	Perm	Init	Description
31:0	CRO		Value.

C.10 PC of logical core 1: 0x41

Value of the PC of logical core 1.

0x41: PC of logical core 1

Bits	Perm	Init	Description
31:0	CRO		Value.

C.11 PC of logical core 2: 0x42

Value of the PC of logical core 2.

0x42: PC of logical core 2

Bits	Perm	Init	Description
31:0	CRO		Value.

C.12 PC of logical core 3: 0x43

Value of the PC of logical core 3.

0x43: PC of logical core 3

Bits	Perm	Init	Description
31:0	CRO		Value.

C.13 PC of logical core 4: 0x44

Value of the PC of logical core 4.

0x44: PC of logical core 4

Bits	Perm	Init	Description
31:0	CRO		Value.

C.14 PC of logical core 5: 0x45

Value of the PC of logical core 5.

0x45: PC of logical core 5

Bits	Perm	Init	Description
31:0	CRO		Value.

C.15 PC of logical core 6: 0x46

Value of the PC of logical core 6.

0x46: PC of logical core 6

Bits	Perm	Init	Description
31:0	CRO		Value.

C.16 PC of logical core 7: 0x47

Value of the PC of logical core 7.

0x47: PC of logical core 7

Bits	Perm	Init	Description
31:0	CRO		Value.

C.17 SR of logical core 0: 0x60

Value of the SR of logical core 0

0x60: SR of logical core 0

Bits	Perm	Init	Description
31:0	CRO		Value.

C.18 SR of logical core 1: 0x61

Value of the SR of logical core 1

0x61: SR of logical core 1

Bits	Perm	Init	Description
31:0	CRO		Value.

C.19 SR of logical core 2: 0x62

Value of the SR of logical core 2

0x62: SR of logical core 2

Bits	Perm	Init	Description
31:0	CRO		Value.

C.20 SR of logical core 3: 0x63

Value of the SR of logical core 3

0x63: SR of logical core 3

Bits	Perm	Init	Description
31:0	CRO		Value.

C.21 SR of logical core 4: 0x64

Value of the SR of logical core 4

0x64: SR of logical core 4

Bits	Perm	Init	Description
31:0	CRO		Value.

C.22 SR of logical core 5: 0x65

Value of the SR of logical core 5

0x65: SR of logical core 5

Bits	Perm	Init	Description
31:0	CRO		Value.

C.23 SR of logical core 6: 0x66

Value of the SR of logical core 6

0x66: SR of logical core 6

Bits	Perm	Init	Description
31:0	CRO		Value.

C.24 SR of logical core 7: 0x67

Value of the SR of logical core 7

0x67: SR of logical core 7

Bits	Perm	Init	Description
31:0	CRO		Value.

D.2 System switch description: 0x01

This register specifies the number of processors and links that are connected to this switch.

0x01: System switch description

Bits	Perm	Init	Description
31:24	RO	-	Reserved
23:16	RO		Number of SLinks on the SSwitch.
15:8	RO		Number of processors on the SSwitch.
7:0	RO		Number of processors on the device.

D.3 Switch configuration: 0x04

This register enables the setting of two security modes (that disable updates to the PLL or any other registers) and the header-mode.

0x04: Switch configuration

Bits	Perm	Init	Description
31	RW	0	0 = SSCTL registers have write access. 1 = SSCTL registers can not be written to.
30:9	RO	-	Reserved
8	RW	0	0 = PLL_CTL_REG has write access. 1 = PLL_CTL_REG can not be written to.
7:1	RO	-	Reserved
0	RW	0	0 = 2-byte headers, 1 = 1-byte headers (reset as 0).

D.4 Switch node identifier: 0x05

This register contains the node identifier.

0x05: Switch node identifier

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:0	RW	0	The unique ID of this node.

D.5 PLL settings: 0x06

An on-chip PLL multiplies the input clock up to a higher frequency clock, used to clock the I/O, processor, and switch, see Oscillator. Note: a write to this register will cause the tile to be reset.

G PCB Layout Design Check List

☑ This section is a checklist for use by PCB designers using the XS2-LF24A-512-FB374. Each of the following sections contains items to check for each design.

G.1 Ground Plane

☐ Each ground ball has a via to minimize impedance and conduct heat away from the device. (Section 11.2)

☐ Other than ground vias, there are no (or only a few) vias underneath or closely around the device. This create a good, solid, ground plane.

G.2 Power supply decoupling

☐ The decoupling capacitors are all placed close to a supply pin (Section 11).

☐ The decoupling capacitors are spaced around the device (Section 11).

☐ The ground side of each decoupling capacitor has a direct path back to the center ground of the device.

G.3 PLL_AVDD

☐ The PLL_AVDD filter (especially the capacitor) is placed close to the PLL_AVDD pin (Section 11).